## **600 Watt Peak Power Zener Transient Voltage Suppressors**

#### **Bidirectional\***

The SMB series is designed to protect voltage sensitive components from high voltage, high energy transients. They have excellent clamping capability, high surge capability, low zener impedance and fast response time. The SMB series is supplied in ON Semiconductor's exclusive, cost-effective, highly reliable Surmetic<sup>™</sup> package and is ideally suited for use in communication systems, automotive, numerical controls, process controls, medical equipment, business machines, power supplies and many other industrial/consumer applications.

#### **Features**

- Working Peak Reverse Voltage Range 9.4 to 77.8 V
- Standard Zener Breakdown Voltage Range 11 to 91 V
- Peak Power 600 W @ 1 ms
- ESD Rating of Class 3 (>16 KV) per Human Body Model
- Maximum Clamp Voltage @ Peak Pulse Current
- Low Leakage < 5 µA Above 10 V
- UL 497B for Isolated Loop Circuit Protection
- Response Time is Typically < 1 ns
- Pb-Free Packages are Available

#### **Mechanical Characteristics:**

CASE: Void-Free, Transfer-Molded, Thermosetting Plastic

FINISH: All External Surfaces are Corrosion Resistant and Leads are

Readily Solderable

#### MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES:

260°C for 10 Seconds

**LEADS:** Modified L-Bend Providing More Contact Area to Bond Pads

**POLARITY:** Polarity Band Will Not be Indicated

**MOUNTING POSITION:** Any

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Power Dissipation (Note 1) @ $T_L = 25$ °C, Pulse Width = 1 ms	P <sub>PK</sub>	600	W
DC Power Dissipation @ T <sub>L</sub> = 75°C Measured Zero Lead Length (Note 2) Derate Above 75°C Thermal Resistance, Junction-to-Lead	$P_{D}$ $R_{ heta JL}$	3.0 40 25	W mW/°C °C/W
DC Power Dissipation (Note 3) @ T <sub>A</sub> = 25°C Derate Above 25°C Thermal Resistance, Junction-to-Ambient	$P_{D}$ $R_{ heta JA}$	0.55 4.4 226	W mW/°C °C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. 10 X 1000 μs, non-repetitive
 2. 1" square copper pad, FR-4 board

3. FR-4 board, using ON Semiconductor minimum recommended footprint, as shown in 403A case outline dimensions spec.

\*Please see P6SMB6.8AT3 to P6SMB200AT3 for Unidirectional devices.



#### ON Semiconductor®

http://onsemi.com

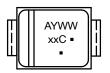
## PLASTIC SURFACE MOUNT ZENER OVERVOLTAGE TRANSIENT SUPPRESSORS 9.4-78 VOLTS **600 WATT PEAK POWER**





**SMB** CASE 403A **PLASTIC** 

#### **MARKING DIAGRAM**



xxC = Device Code

= Assembly Location

WW = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
P6SMBxxCAT3	SMB	2500/Tape & Reel
P6SMBxxCAT3G	SMB (Pb-Free)	2500/Tape & Reel

The "T3" suffix refers to a 13 inch reel.

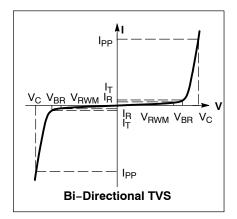
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Devices listed in bold, italic are ON Semiconductor Preferred devices. Preferred devices are recommended choices for future use and best overall value.

#### **ELECTRICAL CHARACTERISTICS**

(T<sub>A</sub> = 25°C unless otherwise noted)

` ''	,
Symbol	Parameter
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current
V <sub>C</sub>	Clamping Voltage @ I <sub>PP</sub>
V <sub>RWM</sub>	Working Peak Reverse Voltage
I <sub>R</sub>	Maximum Reverse Leakage Current @ V <sub>RWM</sub>
$V_{BR}$	Breakdown Voltage @ I <sub>T</sub>
I <sub>T</sub>	Test Current
ΘV <sub>BR</sub>	Maximum Temperature Coefficient of V <sub>BR</sub>



#### **ELECTRICAL CHARACTERISTICS** (Devices listed in bold, italic are ON Semiconductor Preferred devices.)

		V <sub>RWM</sub>	I <sub>R</sub> @	Breakdown Voltage			V <sub>C</sub> @ I <sub>PP</sub>	(Note 6)		C <sub>typ</sub>	
	Device	(Note 4)	V <sub>RWM</sub>	V <sub>BR</sub> Volts (Note 5)		@ I <sub>T</sub>	V <sub>C</sub>	I <sub>PP</sub>	ΘV <sub>BR</sub>	(Note 7)	
Device*	Marking	Volts	μΑ	Min	Nom	Max	mA	Volts	Amps	%/°C	pF
P6SMB11CAT3, G P6SMB12CAT3, G P6SMB13CAT3, G	11C 12C 13C	9.4 10.2 11.1	5 5 5	10.5 11.4 12.4	11.05 12 13.05	11.6 12.6 13.7	1 1 1	15.6 16.7 18.2	38 36 33	0.075 0.078 0.081	865 800 740
P6SMB15CAT3, G P6SMB16CAT3, G P6SMB18CAT3, G P6SMB20CAT3, G	15C 16C 18C 20C	12.8 13.6 15.3 17.1	5 5 5 5	14.3 15.2 17.1 19	15.05 16 18 20	15.8 16.8 18.9 21	1 1 1	21.2 22.5 25.2 27.7	28 27 24 22	0.084 0.086 0.088 0.09	645 610 545 490
P6SMB22CAT3, G P6SMB24CAT3, G P6SMB27CAT3, G P6SMB30CAT3, G	22C 24C 27C 30C	18.8 20.5 23.1 25.6	5 5 5 5	20.9 22.8 25.7 28.5	22 24 27.05 30	23.1 25.2 28.4 31.5	1 1 1	30.6 33.2 37.5 41.4	20 18 16 14.4	0.09 0.094 0.096 0.097	450 415 370 335
<b>P6SMB33CAT3, G</b> P6SMB36CAT3, G P6SMB39CAT3, G P6SMB43CAT3, G	<b>33C</b> 36C 39C 43C	28.2 30.8 33.3 36.8	<b>5</b> 5 5 5	<b>31.4</b> 34.2 37.1 40.9	<b>33.05</b> 36 39.05 43.05	<b>34.7</b> 37.8 41 45.2	1 1 1 1	<b>45.7</b> 49.9 53.9 59.3	<b>13.2</b> 12 11.2 10.1	0.098 0.099 0.1 0.101	<b>305</b> 280 260 240
P6SMB47CAT3, G P6SMB51CAT3, G P6SMB56CAT3, G P6SMB62CAT3, G	47C 51C 56C 62C	40.2 43.6 47.8 53	5 5 5 5	44.7 48.5 53.2 58.9	47.05 51.05 56 62	49.4 53.6 58.8 65.1	1 1 1	64.8 70.1 77 85	9.3 8.6 7.8 7.1	0.101 0.102 0.103 0.104	220 205 185 170
P6SMB68CAT3, G P6SMB75CAT3, G P6SMB82CAT3, G P6SMB91CAT3, G	68C 75C 82C 91C	58.1 64.1 70.1 77.8	5 5 5 5	64.6 71.3 77.9 86.5	68 75.05 82 91	71.4 78.8 86.1 95.5	1 1 1 1	92 103 113 125	6.5 5.8 5.3 4.8	0.104 0.105 0.105 0.106	155 140 130 120

<sup>4.</sup> A transient suppressor is normally selected according to the working peak reverse voltage (V<sub>RWM</sub>), which should be equal to or greater than the DC or continuous peak operating voltage level.

<sup>5.</sup> V<sub>BR</sub> measured at pulse test current I<sub>T</sub> at an ambient temperature of 25°C.
6. Surge current waveform per Figure 2 and derate per Figure 3 of the General Data – 600 Watt at the beginning of this group.

<sup>7.</sup> Bias Voltage = 0 V, F = 1 MHz, T<sub>J</sub> = 25°C

<sup>\*</sup>The "G" suffix indicates Pb-Free package available. Please refer back to Ordering Information on front page.

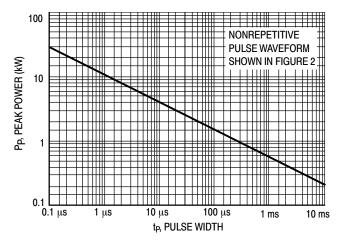


Figure 1. Pulse Rating Curve

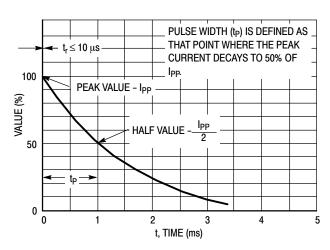


Figure 2. Pulse Waveform

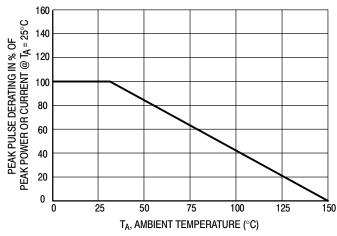


Figure 3. Pulse Derating Curve

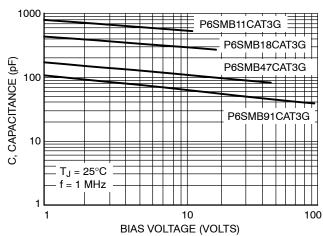
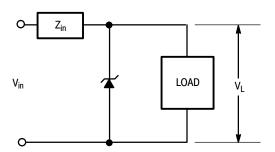


Figure 4. Typical Junction Capacitance vs. Bias Voltage

#### TYPICAL PROTECTION CIRCUIT



#### **APPLICATION NOTES**

#### **RESPONSE TIME**

In most applications, the transient suppressor device is placed in parallel with the equipment or component to be protected. In this situation, there is a time delay associated with the capacitance of the device and an overshoot condition associated with the inductance of the device and the inductance of the connection method. The capacitive effect is of minor importance in the parallel protection scheme because it only produces a time delay in the transition from the operating voltage to the clamp voltage as shown in Figure 4.

The inductive effects in the device are due to actual turn-on time (time required for the device to go from zero current to full current) and lead inductance. This inductive effect produces an overshoot in the voltage across the equipment or component being protected as shown in Figure 5. Minimizing this overshoot is very important in the application, since the main purpose for adding a transient suppressor is to clamp voltage spikes. The SMB series have a very good response time, typically < 1 ns and negligible inductance. However, external inductive effects could produce unacceptable overshoot. Proper circuit layout, minimum lead lengths and placing the

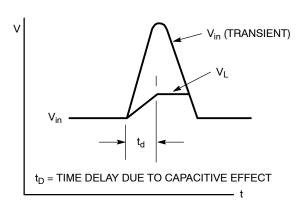
suppressor device as close as possible to the equipment or components to be protected will minimize this overshoot.

Some input impedance represented by  $Z_{in}$  is essential to prevent overstress of the protection device. This impedance should be as high as possible, without restricting the circuit operation.

#### **DUTY CYCLE DERATING**

The data of Figure 1 applies for non-repetitive conditions and at a lead temperature of 25°C. If the duty cycle increases, the peak power must be reduced as indicated by the curves of Figure 6. Average power must be derated as the lead or ambient temperature rises above 25°C. The average power derating curve normally given on data sheets may be normalized and used for this purpose.

At first glance the derating curves of Figure 6 appear to be in error as the 10 ms pulse has a higher derating factor than the 10 µs pulse. However, when the derating factor for a given pulse of Figure 6 is multiplied by the peak power value of Figure 1 for the same pulse, the results follow the expected trend.



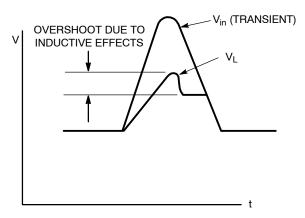


Figure 5.

Figure 6.

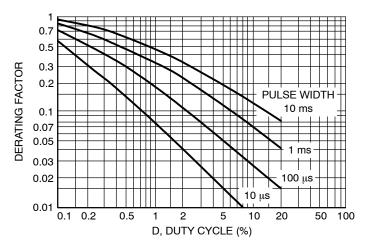


Figure 7. Typical Derating Factor for Duty Cycle

#### **UL RECOGNITION**

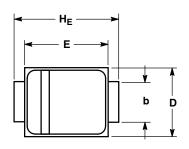
The entire series has *Underwriters Laboratory Recognition* for the classification of protectors (QVGQ2) under the UL standard for safety 497B and File #E210057. Many competitors only have one or two devices recognized or have recognition in a non-protective category. Some competitors have no recognition at all. With the UL497B recognition, our parts successfully passed several tests

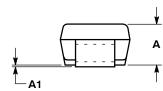
including Strike Voltage Breakdown test, Endurance Conditioning, Temperature test, Dielectric Voltage-Withstand test, Discharge test and several more.

Whereas, some competitors have only passed a flammability test for the package material, we have been recognized for much more to be included in their Protector category.

#### PACKAGE DIMENSIONS

#### **SMB** DO-214AA CASE 403A-03 **ISSUE F**



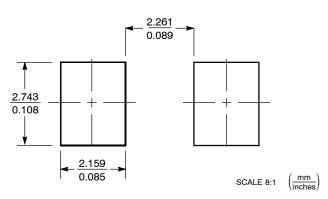


#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.

	М	ILLIMETE	RS	INCHES				
DIM	MIN	NOM	MAX	MIN	NOM	MAX		
Α	1.90	2.13	2.45	0.075	0.084	0.096		
A1	0.05	0.10	0.20	0.002	0.004	0.008		
b	1.96	2.03	2.20	0.077	0.080	0.087		
С	0.15	0.23	0.31	0.006	0.009	0.012		
D	3.30	3.56	3.95	0.130	0.140	0.156		
E	4.06	4.32	4.60	0.160	0.170	0.181		
HE	5.21	5.44	5.60	0.205	0.214	0.220		
L	0.76	1.02	1.60	0.030	0.040	0.063		
L1	0.51 REF				0.020 REF			

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

SURMETIC is a trademark of Semiconductor Components Industries, LLC.

ON Semiconductor and un are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada

Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

# AMEYA360 Components Supply Platform

## **Authorized Distribution Brand:**

























## Website:

Welcome to visit www.ameya360.com

## Contact Us:

## > Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

## > Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

## Customer Service :

Email service@ameya360.com

# Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com